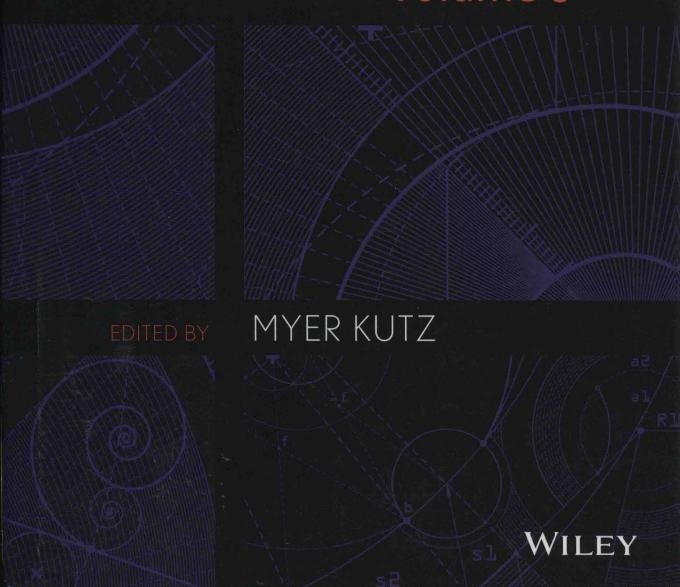


IN SCIENCE AND ENGINEERING

Volume 3

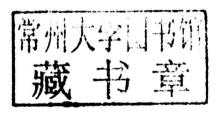


## HANDBOOK OF MEASUREMENT IN SCIENCE AND ENGINEERING

Volume 3

Edited by

**MYER KUTZ** 



WILEY

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HANDBOOK OF MEASUREMENT IN SCIENCE AND ENGINEERING

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#### PREFACE

The idea for the *Handbook of Measurement in Science and Engineering* came from a Wiley book first published over 30 years ago. It was *Fundamentals of Temperature*, *Pressure and Flow Measurements*, written by a sole author, Robert P. Benedict, who also wrote Wiley books on gas dynamics and pipe flow. Bob was a pleasant, unassuming, and smart man. I was the Wiley editor for professional-level books in mechanical engineering when Bob was writing such books, so I knew him as a colleague. I recall meeting him in the Wiley offices at a time when he seemed to be having some medical problems, which he was reluctant to talk about. Recently, I discovered a book published in 1972 by a London firm, Pickering & Inglis, which specializes in religion. This book was *Journey Away from God*, an intriguing title. The author's name was Robert P. Benedict. I do not know whether the two Benedicts are in fact the same person, although Amazon seems to think so. (See the Robert P. Benedict page.) In any case, I do not recall Bob's mentioning the book when we had an occasion to talk.

The moral of this story, if there is one, is that the men and women who contributed the chapters in this handbook are real people, who have real-world concerns, in addition to the expertise required to write about technology. They have families, jobs, careers, and all manner of cares about the minutia of daily life to deal with. And that they have been able to find the time and energy to write these chapters is remarkable. I salute them. I have spent a lot of time in my life writing and editing books. I wrote my first Wiley book somewhat earlier than Bob Benedict wrote his. When Wiley published *Temperature Control* in 1967, I was in my mid-twenties and was a practicing engineer, working on temperature control of the Apollo inertial guidance system at the MIT Instrumentation Lab, where I had done my bachelor's thesis. One of the coauthors of my book was to have been a Tufts Mechanical Engineering Professor by the name of John Sununu (yes, that John Sununu), but he and the other coauthor dropped out of the project before the contract was signed. So I wrote the short book myself.

Bob Benedict's measurement book, the third edition of which is still in print, surfaced several years ago, during a discussion I was having with one of my Wiley editors at the time, Bob Argentieri, about possible projects we could collaborate on. It turned out that no one had attempted to update Benedict's book. I have not been a practicing engineer for some time, so I was not in a position to do an update as a single author—or even with a collaborator or two. Most of my career life has been in scientific and technical publishing, however, and for over a decade I have conceived of, and edited, numerous handbooks for several publishers. (I also write fiction, but that is another story.) So, it was natural for me to think about using Benedict's book as the kernel of a much larger and broader reference work dealing with engineering measurements. The idea, formed during that discussion, that I might edit a contributed handbook on engineering measurements took hold, and with the affable and expert guidance of my other Wiley editor at the time, George Telecki, the volume you are holding in your hands, or reading on an electronic device, came into being.

Like many such large reference works, this handbook went through several iterations before the final table of contents was set, although the general plan for arrangement of chapters has been the same throughout the project. The initial print version of the handbook was divided into two volumes. The chapters were arranged essentially by engineering discipline. The first volume contains 30 chapters related to five engineering disciplines, which are divided into three parts:

- Part I, "Civil and Environmental Engineering," which contains seven chapters, all but one of them dealing with measurement and testing techniques for structural health monitoring, GIS and computer mapping, highway bridges, environmental engineering, hydrology, and mobile source emissions (the exception being the chapter on traffic congestion management, which describes the deployment of certain measurements)
- Part II, "Mechanical and Biomedical Engineering," which contains 16 chapters, all of them dealing with techniques for measuring dimensions, surfaces, mass properties, force, resistive strain, vibration, acoustics, temperature, pressure, velocity, flow, heat flux, heat transfer for nonboiling two-phase flow, solar energy, wind energy, human movement, and physiological flow
- Part III, "Industrial Engineering," which contains seven chapters dealing with statistical quality control, evaluating and selecting technology-based projects, manufacturing systems evaluation, measuring performance of chemical process equipment, industrial energy efficiency, industrial waste auditing, and organizational performance measurement

The second volume contains 23 chapters divided into three parts:

Part IV, "Materials Properties and Testing," which contains 15 chapters dealing with measurement of viscosity, tribology, corrosion, surface properties, and thermal

conductivity of engineering materials; properties of metals, alloys, polymers, and particulate composite materials; nondestructive inspection; and testing of metallic materials, ceramics, plastics, and plastics processing

Part V, "Instrumentation," which contains five chapters covering electronic equipment used for measurements

Part VI, "Measurement Standards," which contains three chapters covering units and standards, measurement uncertainty, and error analysis

This new, third volume of the handbook expands the range of the handbook to cover measurements in physics, electrical engineering, and chemistry. This volume contains 20 chapters divided into two major parts:

Part VII, "Physics and Electrical Engineering," which contains 11 chapters, covering laser-based measurement systems, scanning probe microscopy, scanning tunneling microscopy, photometry, detection and measurement of ionizing radiation, time measurement systems, laboratory-based gravity measurement, cryogenic measurements, temperature-dependent fluorescence measurements, measurement of electrical quantities, and electrical power measurement

Part VIII, "Chemistry" which contains nine chapters, covering chemometrics/ chemical metrology, liquid chromatography, mass spectrometry measurements, basic principles of fluorescence spectroscopy, X-ray absorption spectroscopy, NMR spectroscopy, near-infrared spectroscopy, nanomaterials properties, and chemical sensing

Thanks to Brett Kurzman, my new editor for this volume, and Kari Capone, Allison, McGinniss, and Alex Castro for shepherding the manuscript toward production and to the stalwarts Kristen Parrish and Shirley Thomas for bringing this handbook volume home. Thanks, also, to my wife Arlene, who helps me with everything else.

MYER KUTZ

Delmar, NY October 2015

### **CONTENTS**

#### **VOLUME 3**

LIS	ST OF	CONTR	IBUTORS	xxi
PR	EFACI	Ξ		XXV
PA	RT VII	PHYS	SICS AND ELECTRICAL ENGINEERING	1943
54			rement Techniques	1945
	Cecil .	S. Joseph,	Gargi Sharma, Thomas M. Goyette, and Robert H. Giles	
54.1 Introd			ction, 1945	
			History and Development of the MASER, 1945	
			Basic Laser Physics, 1946	
			Laser Beam Characteristics, 1951	
		54.1.4	Example: CO, Laser Pumped Far-Infrared Gas Laser	
			Systems, 1956	
		54.1.5	Heterodyned Detection, 1959	
		54.1.6	Transformation of Multimode Laser Beams from THz	
			Quantum Cascade Lasers, 1962	
		54.1.7	Suggested Reading, 1965	
	54.2 Laser Measurements: Laser-Based Inverse Synthetic Aperture		-	
			Systems, 1965	
			ISAR Theory, 1966	
		54.2.2	DFT in Radar Imaging, 1967	

viii	CO	NTENTS		
	54.3	54.2.3 54.2.4 54.2.5 54.2.6 Laser In 54.3.1		ı
		54.3.2	Terahertz Polarized Reflection Imaging of Nonmelanoma Skin Cancers, 1981	
		54.3.3	Confocal Imaging, 1985	
		54.3.4		
		54.3.5 54.3.6		
		54.3.7	Laser Raman Spectroscopy, 1996 Suggested Reading, 1997	
References, 1997				
		,		
55	Magn	etic For	ce Images Using Capacitive Coupling Effect	2001
	Byung	I. Kim		
	55.1	Introduc	etion, 2001	
	55.2		nent, 2004	
		55.2.1	Principle, 2004	
			Instrumentation, 2004	
			Approach, 2005	
	55.3		and Discussion, 2006	
		55.3.1	Separation of Topographic Features from Magnetic Force Images Using Capacitive Coupling Effect, 2007	
		55.3.2	Effects of Long-Range Tip-Sample Interaction on	
			Magnetic Force Imaging: A Comparative Study Between Bimorph-Driven System and Electrostatic Force Modulation, 2012	
	55.4	Conclus	sion, 2020	
	Refere	ences, 20	021	
56	Scann	ing Tun	neling Microscopy	2025

# 56.1 Introduction, 2025 56.2 Theory of Operation, 2026 56.3 Measurement of the Tunnel Current, 2030 56.4 The Scanner, 2032 56.5 Operating Mode, 2035